

TECHNICAL DATA SHEET EP691 Clear

06/29/2018

N109 W13300 ELLSWORTH DRIVE GERMANTOWN, WI 53022 262-253-5900 FAX 262-253-5919

DESCRIPTION:

ResinLab® EP691 Clear is a two part unfilled electronic grade epoxy encapsulant designed for medium sized castings. It cures at room temperature to a tough, semi-rigid polymer with a high gloss surface. It will have good wetting and adhesion to most surfaces and is free flowing to penetrate voids and release trapped air. It will have resistance to water, acids, bases, and most organic solvents.

EP691 Clear was formulated to a 2A:1B volume mix ratio for use in side-by-side dispensing cartridges and meter/mix and dispense equipment. EP691 Clear will reach full cure at room temperature within 24 hours. Cure time can be accelerated by the application of heat after the product has gelled. Times and temperatures from 1 hour at 65 °C to 20 minutes at 100 °C are typical for castings less than 50 grams.

TYPICAL PROPERTIES:

All properties given are at 25 °C unless otherwise noted.

Property:	Value:	Test Method or Source:
Color	Clear light amber	Visual
Mix Ratio	Part A to Part B	Calculated
By weight	2.22 to 1	
By volume	2 to 1	
Cure Schedule	1 hour @65 °C	
	20 minutes @ 100 °C	
Viscosity – Part A	13,900 cps @1/s	Rheometer parallel plate 25mm@1/s
Viscosity – Part B	125 cps @1/s	455300006291
Viscosity - Mixed	7,600 cps @1/s	
Specific Gravity – Part A	1.16	Calculated
Specific Gravity – Part B	1.00	
Specific Gravity - Mixed	1.11	
Work Life	~7 hours (50 grams)	Observed, cup and stick
Glass Transition Temperature/Tg	78 ℃	453560822409 by DSC
Hardness	80 Shore D	455300006287/ASTM D2240
Water Absorption	0.07% after 24 hours	457561824543/ASTM D570
Peak Exotherm	No measurable increase in temperature	455300005593 by Type K thermocouple
	observed for 40mL sample	
Tensile Properties:		455300006285/ASTM D638
Strength	8,500 psi	
Elongation	5%	
Modulus	340,000 psi	
Lap Shear Strength		455300005642/ASTM D1002
0.010" bond line Al to Al	1,900 psi	
Compressive Properties:		455300006265/ASTM D695
Strength	28,000 psi	
Modulus	243,000 psi	
Thermal Conductivity by LFA	0.17 W / (m.K)	453560822409/ASTM E1461

RESINLAB L.L.C. MAKES NO EXPRESS OR IMPLIED WARRANTIES OR MERCHANTABILITY, FITNESS OR OTHERWISE with respect to its products. In addition, while the information contained herein is believed to be reliable, no warranty is expressed or implied regarding the accuracy of the data or the results to be obtained from the use thereof. All recommendations or suggestions for use are made without guarantee inasmuch as conditions of use are beyond our control. The properties given are typical values and are not intended for use in preparing specifications. Users should make their own test to determine the suitability of this product for their own purposes.

Page 1 of 2



TECHNICAL DATA SHEET EP691 Clear

06/29/2018

N109 W13300 ELLSWORTH DRIVE GERMANTOWN, WI 53022

262-253-5900 FAX 262-253-5919

Surface Resistivity	3.9 x 10 ¹⁶ ohm/sq (@ 51%RH)	455300006612/ASTM D257
Volume Resistivity	3.5 x 10 ¹⁶ ohm-cm (@ 23 °C)	
Dielectric Constant / Dissipation Factor		455300006513/ASTM D150
@ 100 Hz	3.4, 0.007	
@ 100 kHz	3.2, 0.02	
Dielectric Strength	410 V/mil*	ASTM D149 Method A, immersed in ASTM
		D3487 Type II Oil
Coefficient of Thermal Expansion by TMA	50 ppm/ °C below Tg	455300005340/ASTM E831
	219 ppm/°C above Tg	TMA, 5 °C/min
Temperature Range	-40 to 121 °C**	

^{*} Asterisk denotes values considered typical to associated resin systems or extrapolated from other test results.

INSTRUCTIONS:

- Bring both components to room temperature prior to mixing.
- 2. Cartridge format: Mixer should be attached keeping the cartridge vertical and any air pocket purged this way. After the mixer contains material, the mixer tip can be dropped to dispense pre-bleed amount. Attach a new static mixer with each cartridge, then pre-bleed the first 3 inches of dispensed material or until a uniform color is obtained. Maintain adequate velocity during dispensing to ensure complete mixing.
- 3. Bulk format: weigh and mix parts A and B accurately and thoroughly, scraping sides of container often. Do not pour from mixing container, transfer to a new container as residual unmixed material may cause a tacky spot on the surface of the casting. Maintain adequate velocity during dispensing to ensure complete mixing.
- 4. Allow to cure undisturbed until product is fully gelled or tack-free to the touch.
- 5. Clean up uncured resin with suitable organic solvent such as MEK, acetone or other organic solvent.

SHELF LIFE AND STORAGE: 12 months at 25 °C

Specialty packaging may be less.

Many epoxy resin systems are prone to crystallization as epoxy resin is a super-cooled fluid. This condition may give the product a gritty or grainy appearance (or hazy in clear products). Products in this state will not usually cure to normal and expected properties. In extreme cases it may appear solid and cured. Fluctuating temperatures (within 5 to 50 °C) aggravate this phenomenon. Heating the individual component to 50 to 60 °C while stirring can usually restore products to original state. Storage at 25 +/- 10 °C is optimum for most products.

RESINLAB L.L.C. MAKES NO EXPRESS OR IMPLIED WARRANTIES OR MERCHANTABILITY, FITNESS OR OTHERWISE with respect to its products. In addition, while the information contained herein is believed to be reliable, no warranty is expressed or implied regarding the accuracy of the data or the results to be obtained from the use thereof. All recommendations or suggestions for use are made without guarantee inasmuch as conditions of use are beyond our control. The properties given are typical values and are not intended for use in preparing specifications. Users should make their own test to determine the suitability of this product for their own purposes. Page 2 of 2

^{**} Temperature Rating is based on average design requirements and is not intended as a guarantee of suitability for all applications operating at that temperature.

^{***} This TDS contains values that have been updated. The values reported in this technical data sheet are typical values of the product, and are highly dependent on test conditions and methodology. We actively seek the most precise and accurate ways to measure and interpret performance of our products, and to update estimated values with measured values. The formula has not been revised or changed in any way. Although the values on paper have changed, you can expect the same performance of the product.